

# SOD-123FL Plastic-Encapsulate Diodes

## S2AL-S2ML General Purpose Rectifier Diodes

### Features

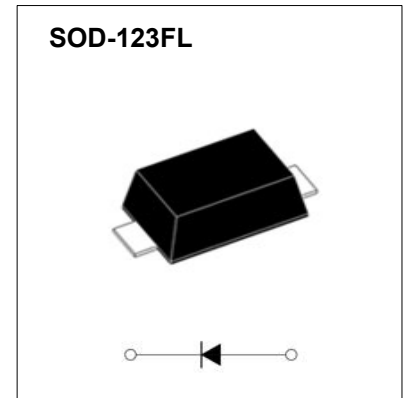
- $I_o$  2A
- VRRM 50V-1000V
- Low forward voltage drop
- High surge current capability
- Glass passivated chip junction

### Applications

- Rectifier

### Marking

- S2X  
X=A To M



### Limiting Values (Absolute Maximum Rating)

Item	Symbol	Unit	Conditions	S						
				2AL	2BL	2DL	2GL	2JL	2KL	2ML
Repetitive Peak Reverse Voltage	$V_{RRM}$	V		50	100	200	400	600	800	1000
Maximum RMS Voltage	$V_{RMS}$	V		35	70	140	280	420	560	700
Maximum DC Blocking Voltage	$V_{DC}$	V		50	100	200	400	600	800	1000
Average Forward Current	$I_{F(AV)}$	A	60Hz Half-sine wave Resistance load,	2						
Surge(Non-repetitive)Forward Current	$I_{FSM}$	A	60Hz Half-sine wave,1 cycle, $T_a=25^{\circ}C$	50						
Junction Temperature	$T_J$	$^{\circ}C$		-55~+150						
Storage Temperature	$T_{STG}$	$^{\circ}C$		-55 ~ +150						

### Electrical Characteristics ( $T_a=25^{\circ}C$ Unless otherwise specified)

Item	Symbol	Unit	Test Condition	Typ	Max
Peak Forward Voltage	$V_{FM}$	V	$I_{FM}=2.0A$		1.1
Peak Reverse Current	$I_{RRM1}$	$\mu A$	$V_{RM}=V_{RRM}$	$T_a=25^{\circ}C$	5
	$I_{RRM2}$			$T_a=125^{\circ}C$	50
Reverse Recovery Time	$T_{rr}$	us	$I_F=0.5A$ $I_R=1A$ $I_{RR}=0.25A$	2.0	
Juction Capacitance	$C_j$	pF	Measured at 1MHZ and Applied Reverse Voltage of 4.0 V.D.C.	8	
Thermal Resistance	$R_{\theta JA}$	$^{\circ}C/W$	Between junction and ambient	62	
	$R_{\theta JL}$		Between junction and lead	11	
	$R_{\theta JC}$		Between junction and case	4	

### Notes:

Thermal resistance from junction to ambient and from junction to lead mounted on FR4 PCB double sided copper mini pad

# Typical Characteristics

FIG.1: FORWARD CURRENT DERATING CURVE

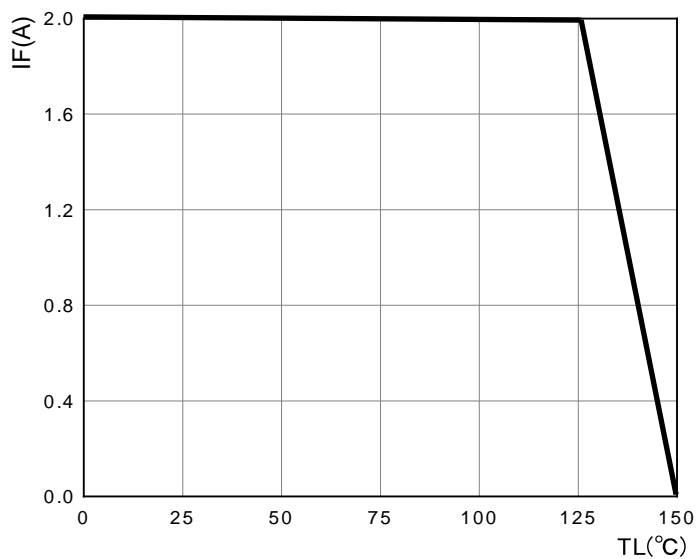


FIG.2: MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

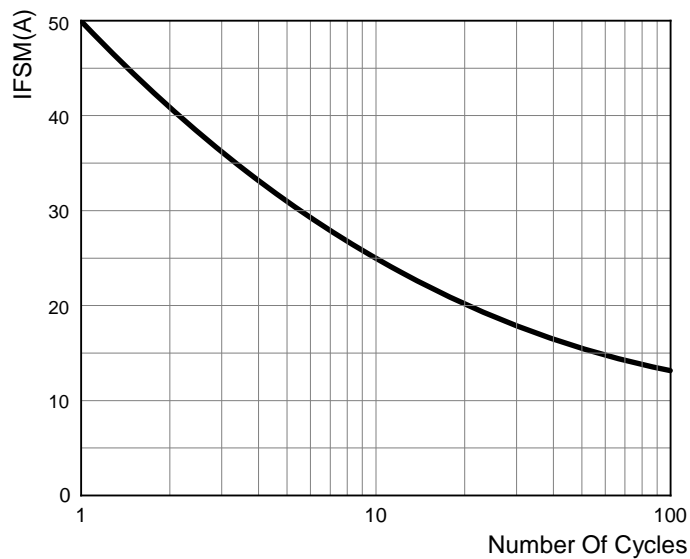


FIG.3 : TYPICAL FORWARD CHARACTERISTICS

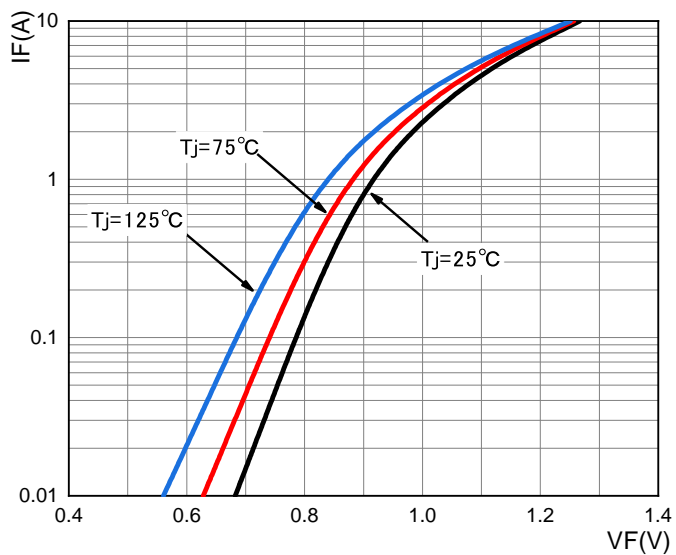
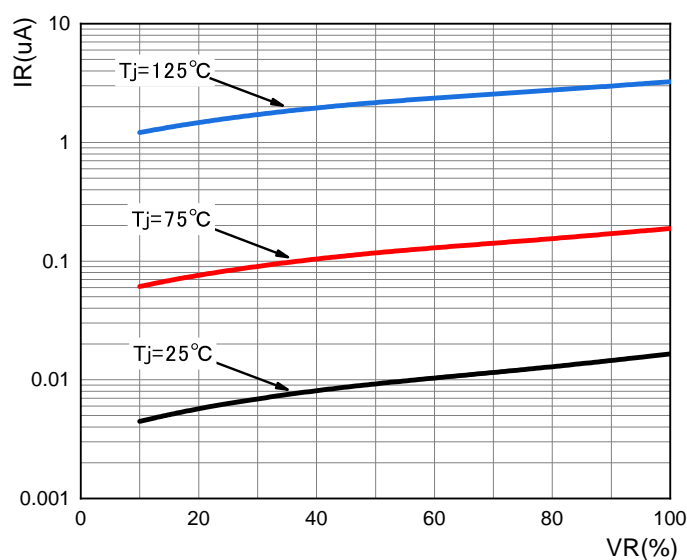
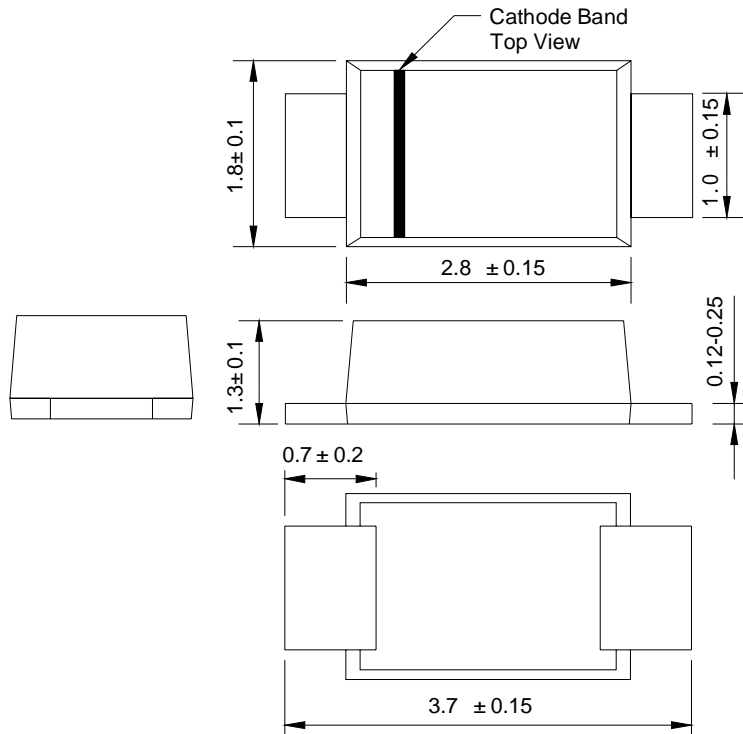


FIG.4 TYPICAL REVERSE CHARACTERISTICS

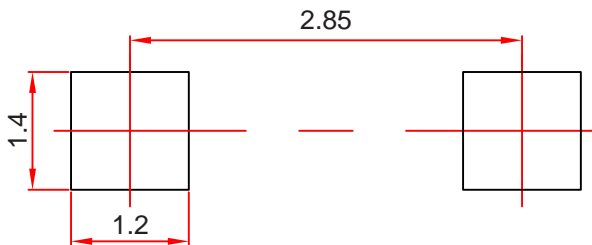


## SOD-123FL Package Outline Dimensions



Dimensions in millimeters

## SOD-123FL Suggested Pad Layout



### Note:

1. Controlling dimension: in millimeters.
2. General tolerance:  $\pm 0.05$  mm.
3. The pad layout is for reference purposes only.

## Ordering Information

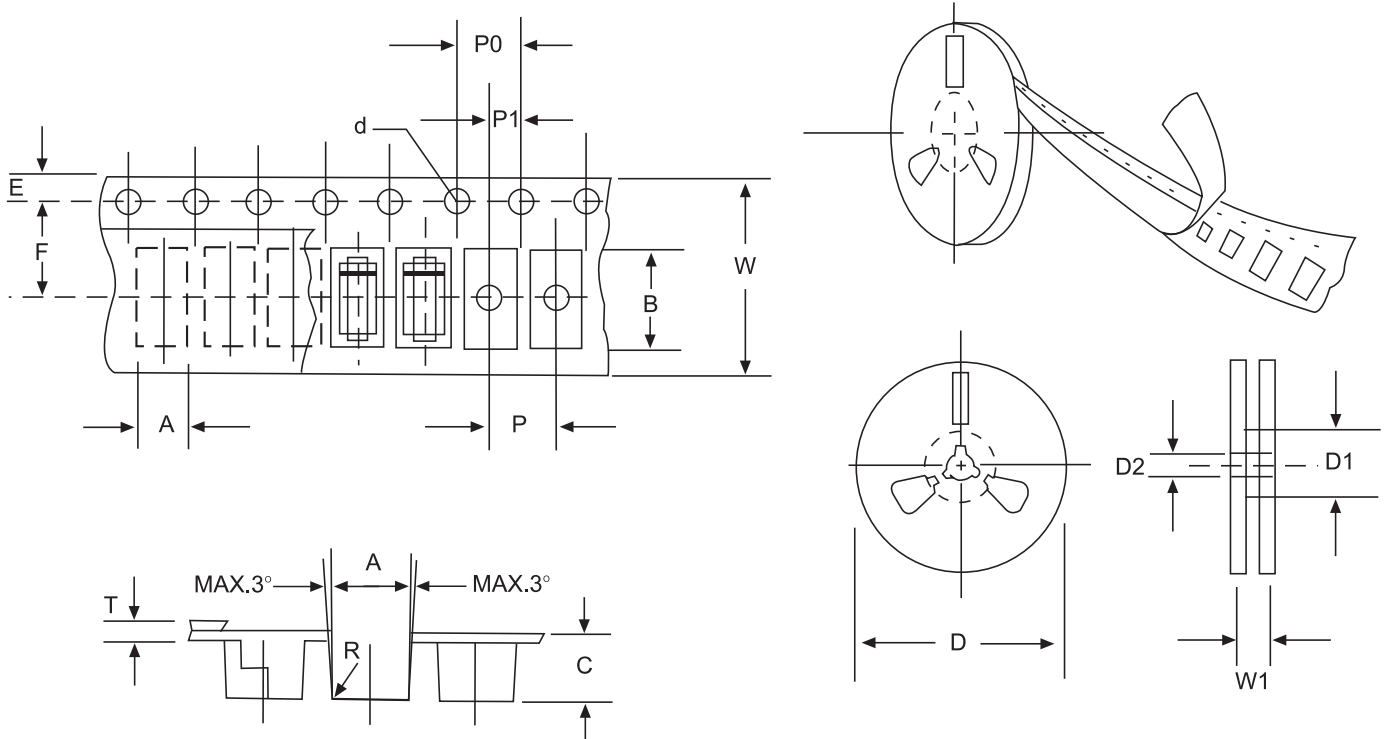
Part Number	Package	Shipping Quantity
S2AL-S2ML	SOD-123FL	3000/tape&Reel

## Marking Diagram



X: From A To M

# Reel Taping Specifications For Surface Mount Devices–SOD-123FL



**FIG : CONFIGURATION OF SURFACE MOUNTED DEVICES TAPING**

ITEM	SYMBOL	SOD-123FLmm(inch)
Carrier width	A	2.05±0.1(0.081±0.004)
Carrier length	B	3.95±0.1(0.156±0.004)
Carrier depth	C	1.45±0.1(0.057±0.004)
Sprocket hole	d	1.55±0.05(0.061±0.002)
Reel outside diameter	D	178±2.0(7.0±0.079)
Reel inner diameter	D1	54±1.0(2.13±0.039)
Feed hole diameter	D2	13±0.5(0.512±0.020)
Sprocket hole position	E	1.75±0.1(0.069±0.004)
Punch hole position	F	3.50±0.1(0.138±0.002)
Punch hole pitch	P	4.0±0.1(0.157±0.004)
Sprocket hole pitch	P0	4.0±0.1(0.157±0.004)
Embossment center	P1	2.0±0.1(0.079±0.004)
Total tape thickness	T	0.21±0.25(0.008±0.010)
Tape width	W	8.0±0.2(0.315±0.008)
Reel width	W1	10.0±2.0(0.394±0.079)

NOTE: Devices are packed in accordance with EIA standard RS-481-A and specification given above.